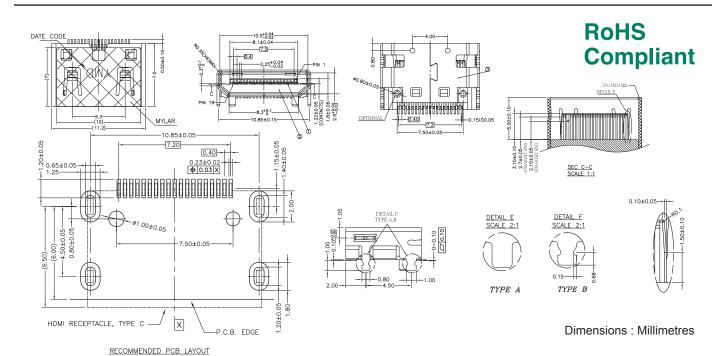
# HDMI Receptacle Type C Pitch O.4mm SMT Type





## **Specifications:**

Operating Current : 0.5A Max.

Operation Temperature : -20°C to +80°C

Thermal Shock : -55°C ±3°C for 30 minutes, 85°C ±3°C For 30 Minutes

Dielectric Withstanding Voltage : 500 Volts AC Between Adiacent Terminal (Unmate)

300 Volts AC Between Adiacent Terminal (mate)

Insulation Resistance :  $100M\Omega$  min. (unmated);  $10M\Omega$  min. (mate)

Item	Part Name	Qty	Material	Finish
1	Contact	1 Set	Brass C2680R-H, T = 0.15	Gold Plated over Nickel
2	Housing	1 Pcs	LCP + 30% G.F.	-
3	Shell	1 Pcs	Brass C2680R-H, T = 0.35	Gold Plated Over Nickel

#### Note:

#### 1. Mechanical:

Insertion Force : 4.5 kg Max. Withdraw Force : 0.3 kg Max.

2. Electrical:

Contact Current Rating : 0.5A Min.

Voltage Rating : 40V AC (RMS)

Dielectric Withstanding Voltage : 500V AC for 1 minute

 $\begin{tabular}{ll} Insulation Resistance & : 100M\Omega \ Min. \\ Contact Resistance & : 30m\Omega \ Max. \\ \end{tabular}$ 

3. Environmental:

Operating Temperature :  $-20^{\circ}$ C to  $+80^{\circ}$ C Storage Temperature :  $-40^{\circ}$ C to  $+85^{\circ}$ C

www.element14.com www.farnell.com www.newark.com



# **HDMI Receptacle**



## **Ordering Information**

 $\frac{60}{(1)} \, \frac{\text{U}}{(2)} \, \frac{019}{(3)} \, \frac{\text{S}}{(4)} \, \frac{3}{(5)} \, \frac{*}{(6)} \, \frac{*}{(7)} \, \frac{*}{(8)} \, - \frac{*}{(9)} \, \frac{*}{(10)} \, \frac{-*}{(11)(12)}$ 

1. Series No.

60: HDMI Connector, Type C

2. Tail Construction Type

U: SMT Type

3. Number of Pin

019: 19 Positions

4. Contact & Conneting Type

S: Socket

5. Colour Codes:

3: Black

6. Contact Plating

4 : Gold Flash Plated over 30µ" Nickel Underplating

5 : 15μ" Gold Plated in contact area and Gold flash plated in solder area over 50μ" nickel underplating

6: 30μ" Gold Plated in contact area and Gold flash plated in solder area over 50μ" nickel underplating

7. Shell Construction

0: Solder tail is type A and through Hole type

1: Solder tail is type A and through Hole type

8. Shell Plating

N: Solderable Nickel Plated

L: Au:3µ" Gold Mini all Plated

4: Gold Flash. All Plating

9. Suffix No. 1

A: With Logo

B: Without Logo

C: Without Logo and with Mylar

10. Suffix No. 2

0 : Housing without Post

1: Housing with Post

11. Suffix No. 3

\*: Customer Code

12. Suffix No. 4

5: With D/C

Note: Without D/C

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